

TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TD62306P, TD62306F

6CH LOW SATURATION SINK DRIVER

The TD62306P, TD62306F are comprised of six NPN low saturation drivers.

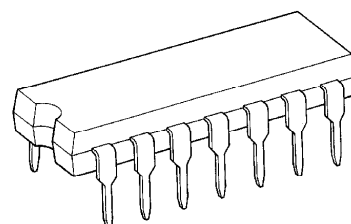
All units feature integral clamp diodes for switching inductive loads and protective diodes against a negative input voltage.

Applications include relay, hammer, lamp and LED driver.

FEATURES

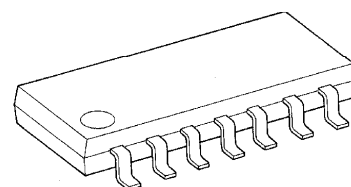
- Low saturation output voltage : $V_{CE(sat)} = 0.6V$ (Max.)
@ $I_{OUT} = 120mA$
- Output rating (single output) 20V (Min.) / 150mA (Max.)
- Inputs compatible with 5~15V PMOS, CMOS
- Input protective diodes against a negative input voltage
- Package type-P : DIP-14 pin
- Package type-F : SOP-14 pin

TD62306P



DIP14-P-300-2.54

TD62306F

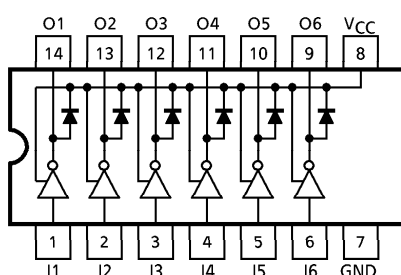


SOP14-P-225-1.27

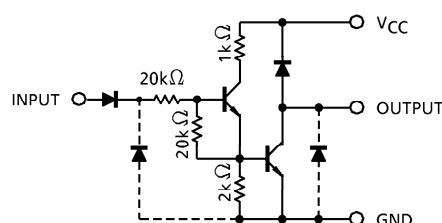
Weight

DIP14-P-300-2.54 : 1.11g (Typ.)
SOP14-P-225-1.27 : 0.16g (Typ.)

PIN CONNECTION (TOP VIEW)



SCHEMATICS (EACH DRIVER)



(Note) The input and output parasitic diodes cannot be used as clamp diodes.

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MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Supply Voltage		V _{CC}	– 0.5~20	V
Output Sustaining Voltage		V _{CE (SUS)}	– 0.5~V _{CC} + 0.5	V
Output Current		I _{OUT}	150	mA / ch
Input Voltage		V _{IN}	– 37~20	V
Input Current		I _{IN}	1.5	mA
Clamp Diode Reverse Voltage		V _R	20	V
Clamp Diode Forward Current		I _F	120	mA
Power Dissipation	P	P _D	1.0	W
	F		0.625 (Note)	
Operating Temperature	P	T _{opr}	– 30~75	°C
	F		– 40~85	
Storage Temperature		T _{stg}	– 55~150	°C

(Note) On Glass Epoxy PCB (50×50×1.6mm Cu 30%)

RECOMMENDED OPERATING CONDITIONS (Ta = – 40 ~ 85°C for Type-F and Ta = – 30 ~ 75°C for Type-P)

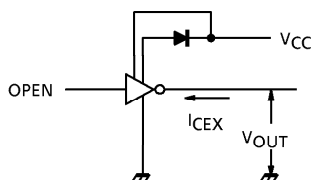
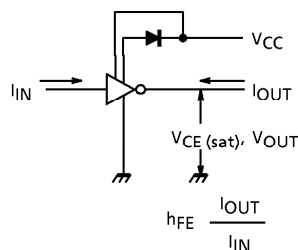
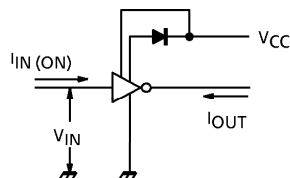
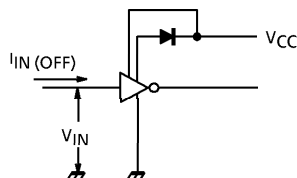
CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V _{CC}	—	4.75	—	18	V
Output Current	I _{OUT}	DC 1 Circuit	0	—	120	mA / ch
		T _{pw} = 25ms, Duty = 10%, 6 Circuits	0	—	100	
Input Voltage	V _{IN}	—	– 35	—	V _{CC}	V
Clamp Diode Reverse Voltage	V _R	—	—	—	18	V
Clamp Diode Forward Current	I _F	—	—	—	120	mA
Power Dissipation	P	P _D	—	—	0.44	W
	F		(Note)	—	0.325	

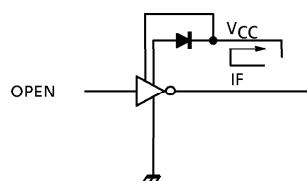
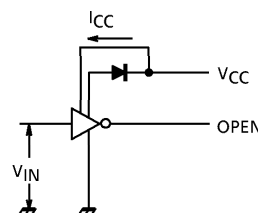
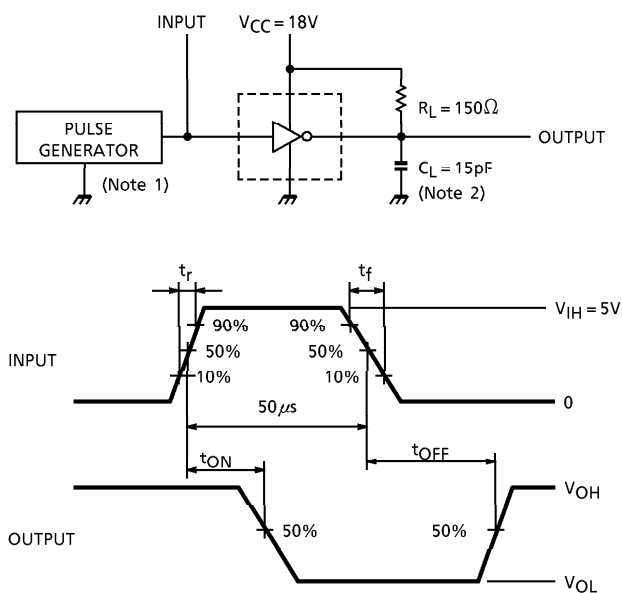
(Note) On Glass Epoxy PCB (50×50×1.6mm Cu 30%)

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Output Leakage Current	P	I_{CEX}	1	$V_{CC} = 18V$ $V_{OUT} = 18V$	$T_a = 75^\circ C$	—	—	100	μA
	F				$T_a = 85^\circ C$	—	—	100	
Output Saturation Voltage		$V_{CE(sat)}$	2	$V_{CC} = 5V, I_{IN} = 0.2mA$ $I_{OUT} = 120mA$		—	0.45	0.6	V
DC Forward Current Transfer Ratio		h_{FE}	2	$V_{CC} = 5V, V_{OUT} = 2V$ $I_{OUT} = 120mA$		1000	—	—	—
Input Current	Output On	$I_{IN(ON)}$	3	$V_{IN} = 5V, I_{OUT} = 120mA$		—	0.16	0.23	mA
	Output Off	$I_{IN(OFF)}$	4	$V_{IN} = 15V, I_{OUT} = 120mA$		—	0.66	0.94	
Clamp Diode Forward Voltage		V_F	5	$I_F = 120mA$		—	1.25	1.6	V
Supply Current	Output On	$I_{CC(ON)}$	6	$V_{CC} = V_{IN} = 5V$		—	4.0	6.0	mA / Gate
	Output Off	$I_{CC(OFF)}$	6	$V_{CC} = V_{IN} = 15V$		—	14.0	22	
Turn-On Delay		t_{ON}	7	$V_{CC} = 18V, R_L = 150\Omega$ $C_L = 15pF$		—	0.1	—	μs
Turn-Off Delay		t_{OFF}				—	0.8	—	μs

TEST CIRCUIT

1. I_{CEX} 2. $h_{FE}, V_{CE(sat)}$ 3. $I_{IN(ON)}$ 4. $I_{IN(OFF)}$ 

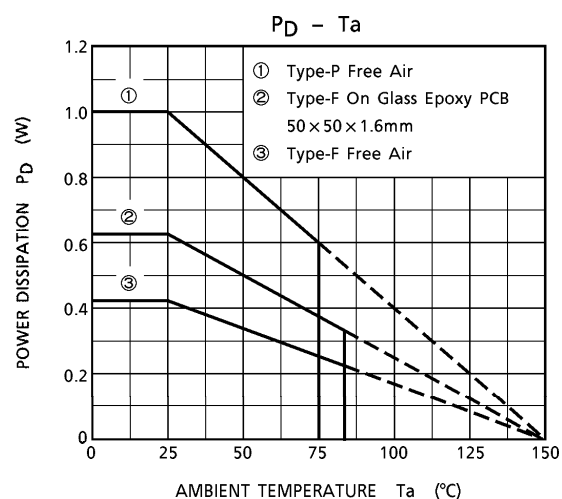
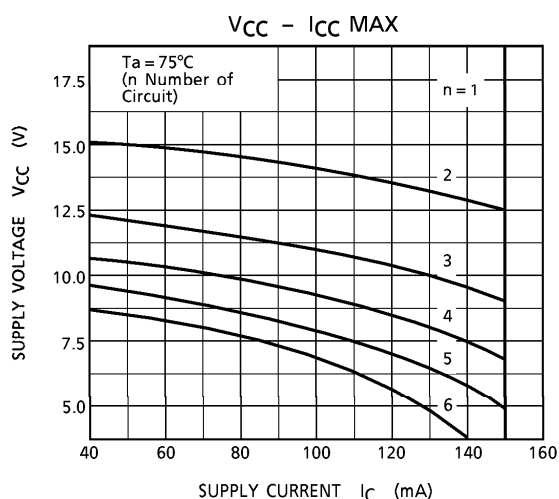
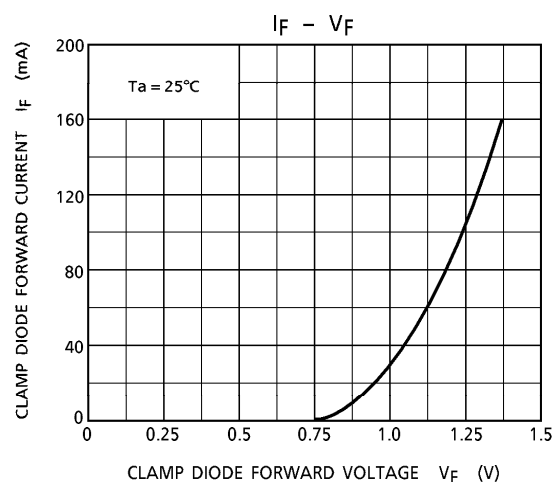
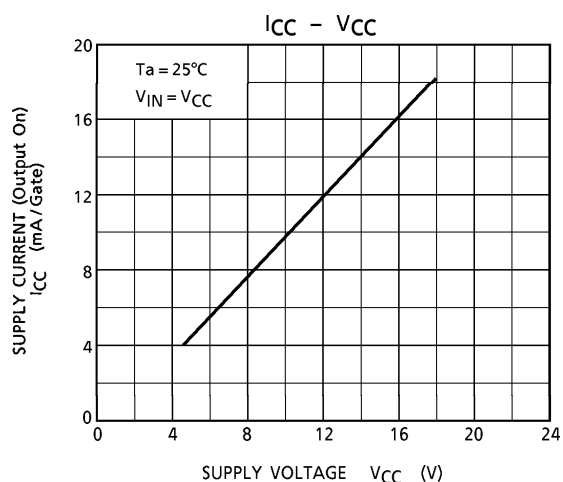
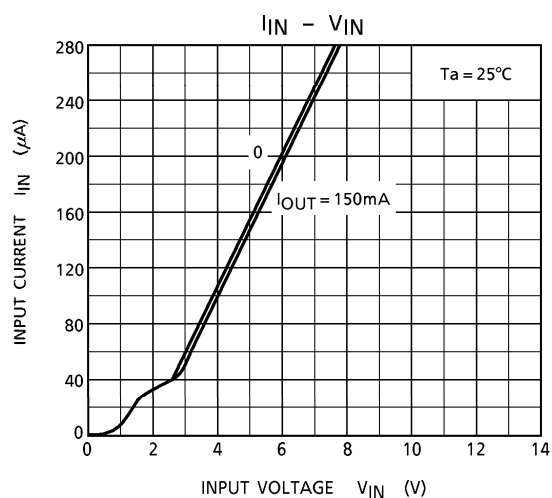
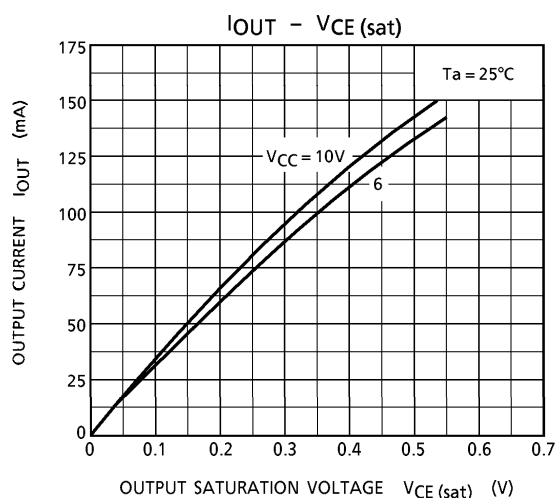
5. V_F

6. I_{CC}

7. t_{ON} , t_{OFF}


(Note 1) Pulse Width $50\mu s$, Duty Cycle 10%
Output Impedance 50Ω , $t_r \leq 5ns$, $t_f \leq 10ns$

(Note 2) C_L includes probe and jig capacitance.

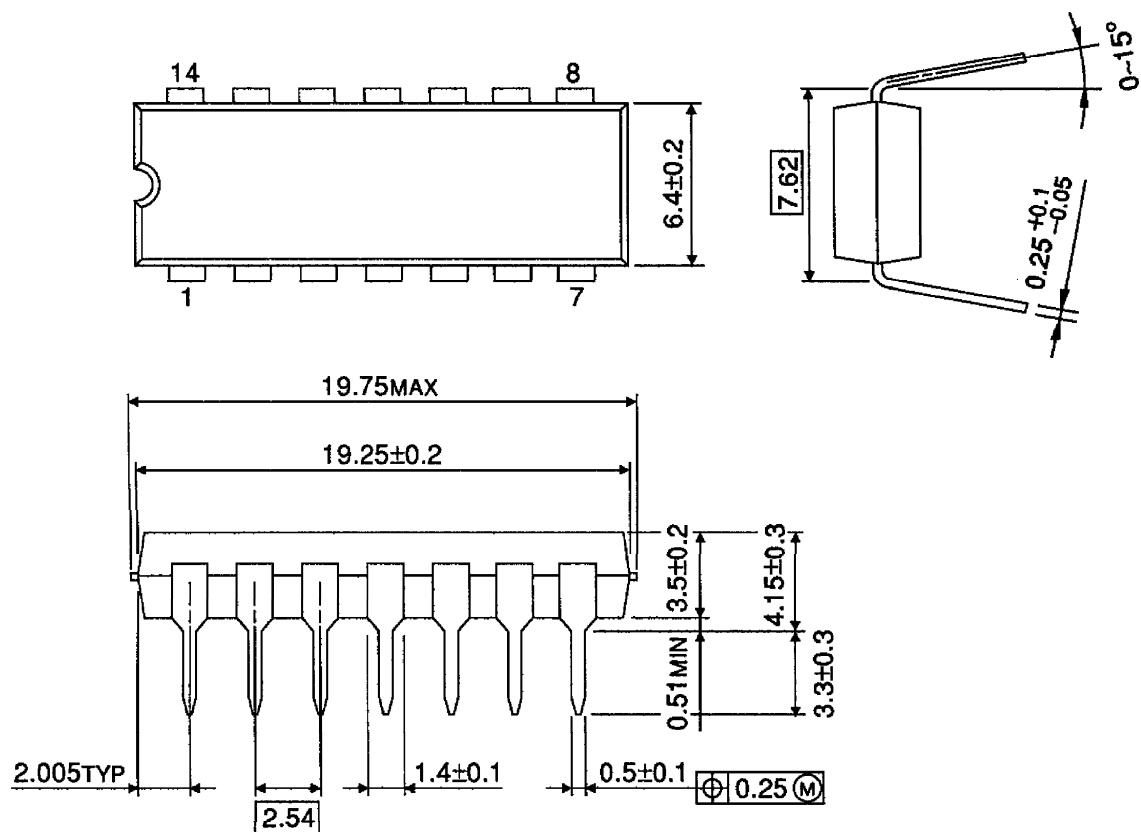
PRECAUTIONS for USING

Utmost care is necessary in the design of the output line, V_{CC} and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.



OUTLINE DRAWING
DIP14-P-300-2.54

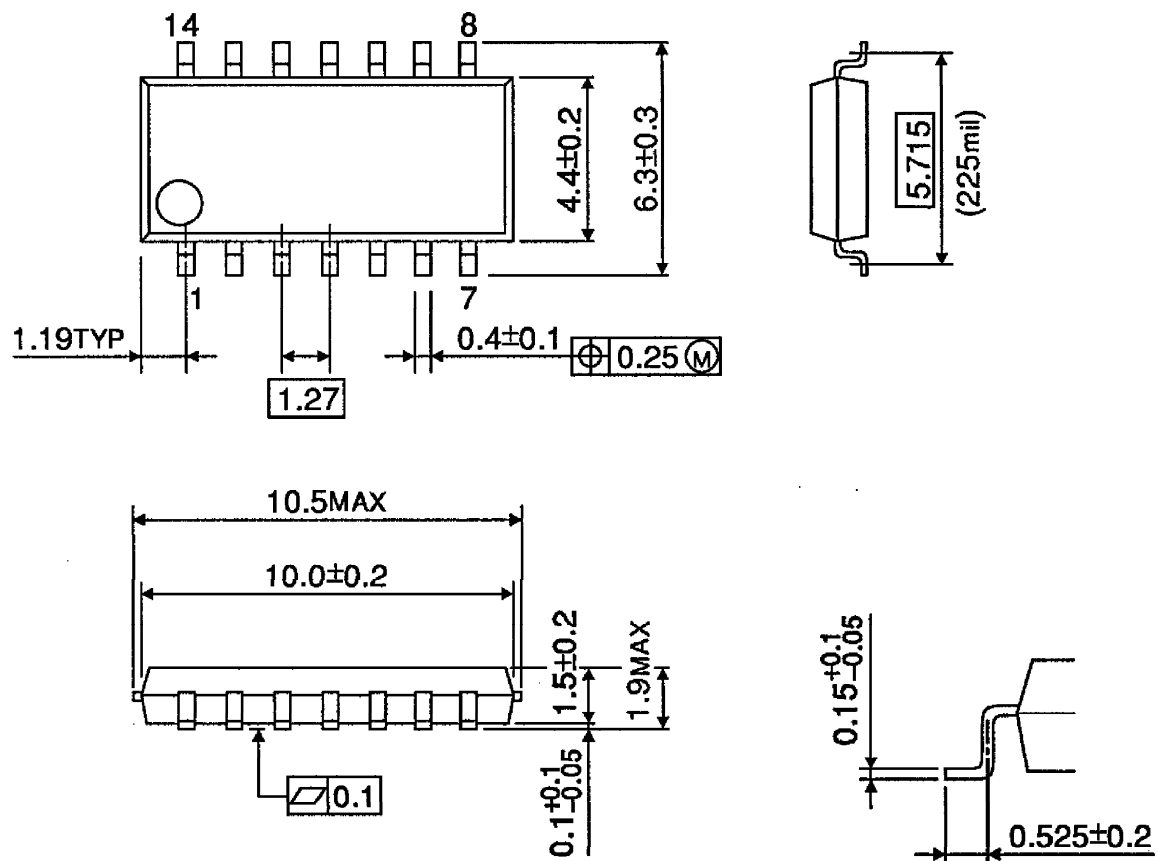
Unit : mm



Weight : 1.11g (Typ.)

OUTLINE DRAWING
SOP14-P-225-1.27

Unit : mm



Weight : 0.16g (Typ.)